DECLARATION FOR PATENT APPLICATION

AS 8	below named	inventor(s)	(we) hereby	declare that

My (our) residence(s), post office address(es) and citizenship(s) is (are) the same as stated below next to my (our)

and joint inventor (if plural na sought on the invention entitle	n original, first and sole inventor mes are listed below) of the sub ed: OF SILICON WAFER	(if only one name is listed bel ject matter which is claimed a	ow) or an origi nd for which a	nal, first patent is
the specification of which is a	tached hereto unless the follow	ing how is charked:		
	as United Stat			
	Dication Number	es Application Number		or
and was amended on	(if ap	unicable		
	(, 4	paramoj.		
including the claims, as amen	have reviewed and understand ded by any amendment referred o disclose information which is n	I to above,		
application(s) for patent or inv	ority benefits under Title 35, Un entor's certificate listed below a having a filing date before that	nd have also identified below:	any foreign and	plication for
	Prior Foreign Application(s):			
(Number)	(Country)	(Day/Month/Year)	Priority Claimed: YES NO	
2003-411287	Japan	10/12/2003	, x	
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				i
I (we) hereby claim the benefit application(s) listed below:	t under Title 35, United States C	ode, §119(e) of any United St	ates provisions	ıl
	(Application Number)	(Filin	ng Date)	***************************************
States application in the mann	under Title 35, United States C ect matter of each of the claims er provided by the first paragrap ase information which is materia	of this application is not disclo	sed in the prio	r United

Regulation, §1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(Application Serial No.)	(Filing date)	(STATUS-patented, pending, abandoned)

DECLARATION FOR PATENT APPLICATION

(we) hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all it the Patent and Trademark Office connected therewith and to act in accordance with the instructions from St alent Office:	usiness 1
alent Office;	ida

Lloyd McAulay, Reg. No. 20,423; J. Harold Nissen, Reg. No. 17,283: Jules E. Goldberg. Reg. No. 24,408; Gerald H. Kiel, Reg. No. 25,116: Eugene LeDonne, Reg. No. 35,930; Stephen M. Chin, Reg. No. 39,938; Arthur Dresner. Reg. No. 36,612; Samir R. Patel. Reg. No. 44,998

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I (we) hereby declare that all statements made herein of my (our) own knowledge are true, and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that withful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

	or 1st inventor (given name, family name):	Sakae Koya	ita
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DECLARATION FOR PATENT APPLICATION

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Inventor's signature: <u>Fagushige Takaishi</u> Date: 20, Dec. 2005